



GM72V66841ET/ELT

2,097,152 WORD x 8 BIT x 4 BANK
SYNCHRONOUS DYNAMIC RAM

Description

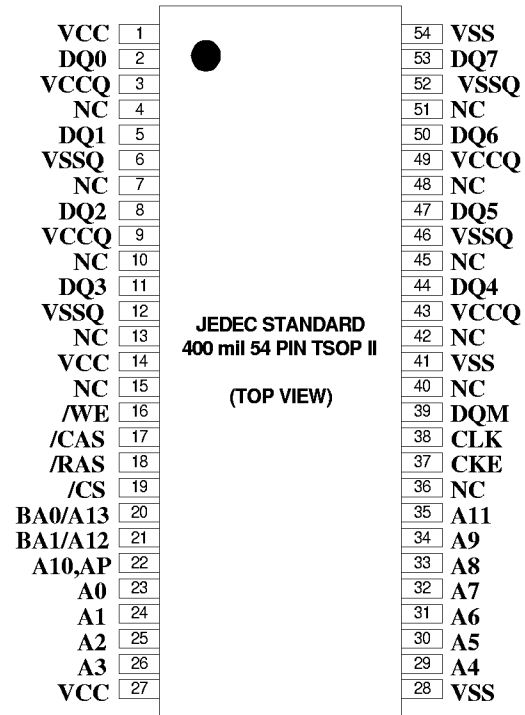
The GM72V66841ET/ELT is a synchronous dynamic random access memory comprised of 67,108,864 memory cells and logic including input and output circuits operating synchronously by referring to the positive edge of the externally provided Clock.

The GM72V66841ET/ELT provides four banks of 2,097,152 word by 8 bit to realize high bandwidth with the Clock frequency up to 125 Mhz.

Features

- * PC100,PC66 Compatible
7K(PC100,2-2-2), 7J(PC100,3-2-2),10K(PC66)
- * 3.3V single Power supply
- * LVTTTL interface
- * Max Clock frequency
100/125 MHz
- * 4,096 refresh cycle per 64 ms
- * Two kinds of refresh operation
Auto refresh / Self refresh
- * Programmable burst access capability ;
- Sequence:Sequential / Interleave
- Length :1/2/4/8/FP
- * Programmable $\overline{\text{CAS}}$ latency : 2/3
- * 4 Banks can operate independently or simultaneously
- * Burst read/burst write or burst read/single write operation capability
- * Input and output masking by DQM input
- * One Clock of back to back read or write command interval
- * Synchronous Power down and Clock suspend capability with one Clock latency for both entry and exit
- * JEDEC Standard 54Pin 400mil TSOP II Package

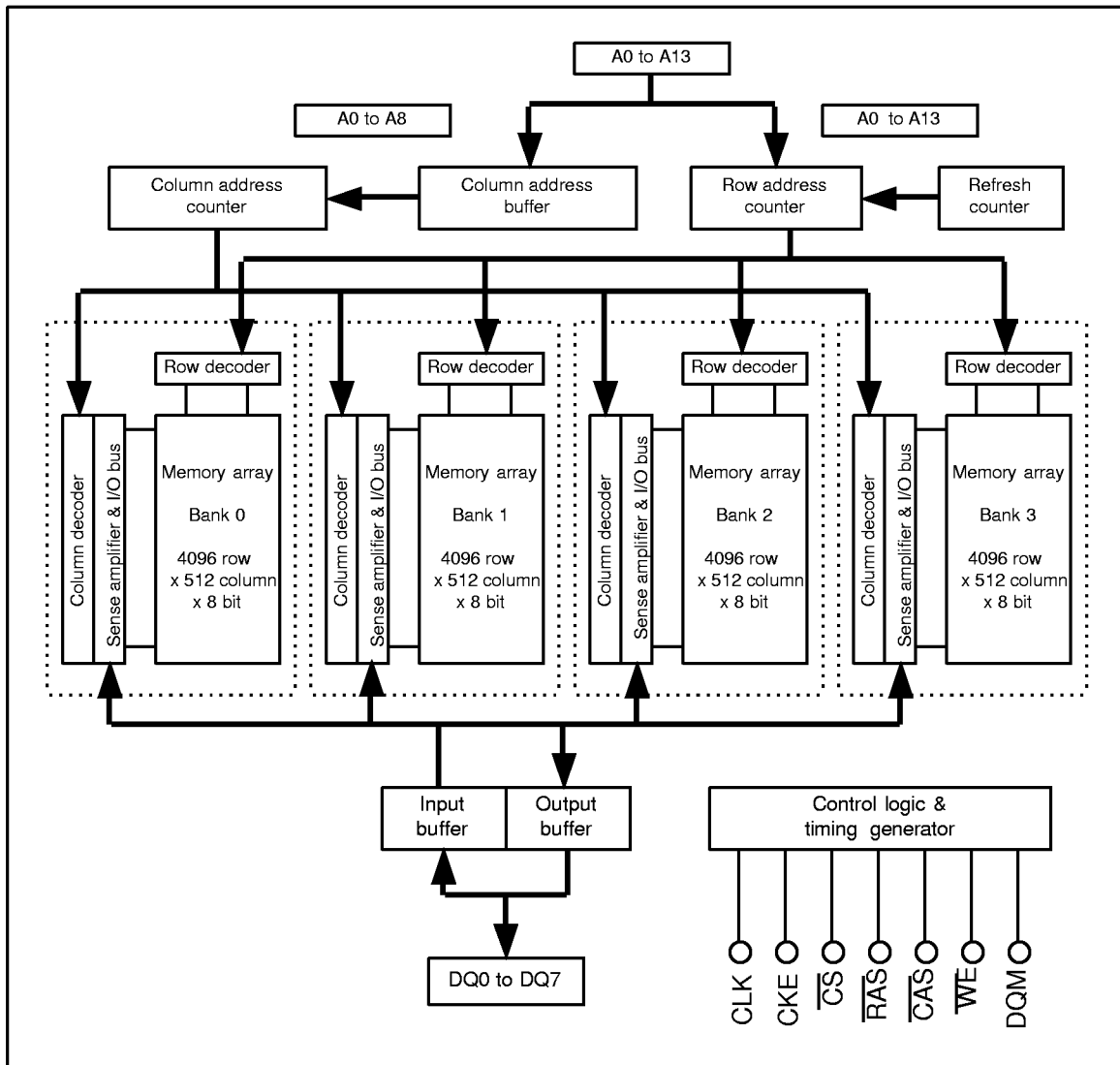
Pin Configuration



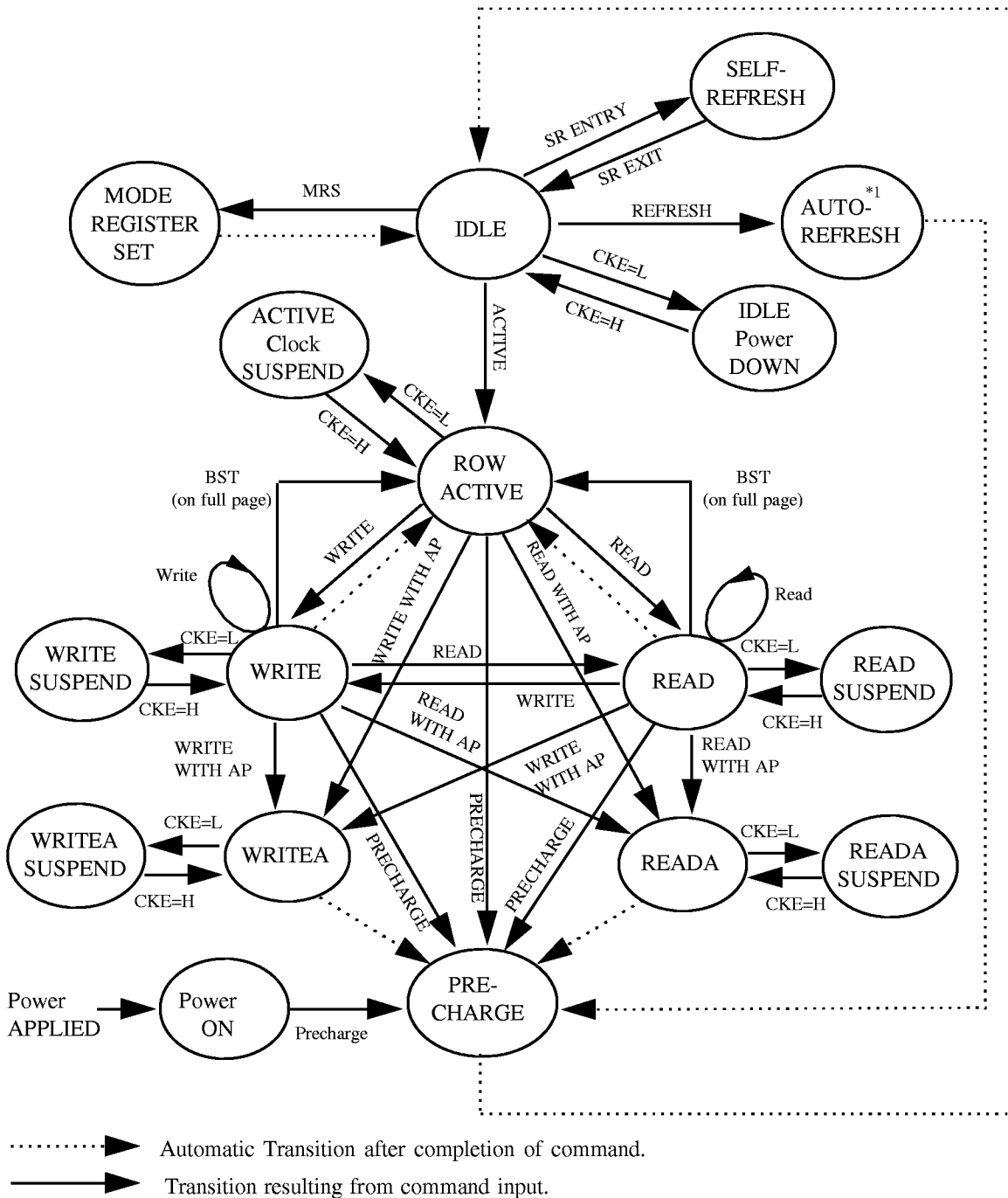
Pin Name

CLK	Clock
CKE	Clock Enable
$\overline{\text{CS}}$	Chip Select
$\overline{\text{RAS}}$	Row Address Strobe
$\overline{\text{CAS}}$	Column Address Strobe
$\overline{\text{WE}}$	Write Enable
A0~A9,A11	Address input
A10 / AP	Address input or Auto Precharge
BA0/A13 ~BA1/A12	Bank select
DQ0~DQ7	Data input / Data output
DQM	Data input / output Mask
VCCQ	Vcc for DQ
VSSQ	Vss for DQ
VCC	Power for internal circuit
VSS	Ground for internal circuit
NC	No Connection

Block Diagram



64M SDRAM Function State Diagram



Note: 1. After the auto-refresh operation, Precharge is performed automatically and enter the IDLE state.

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	Note
Voltage on any pin relative to Vss	V _T	-0.5 to V _{CC} +0.5 (≤ 4.6 (max))	V	1
Supply voltage relative to Vss	V _{CC}	-0.5 to +4.6	V	1
Short circuit output current	I _{OUT}	50	mA	
Power dissipation	P _T	1.0	W	
Operating temperature	T _{opr}	0 to +70	C	
Storage temperature	T _{stg}	-55 to +125	C	

Notes : 1. Respect to Vss

Recommended DC Operating Conditions (T_a = 0 to + 70C)

Parameter	Symbol	Min	Max	Unit	Note
Supply voltage	V _{CC} , V _{CCQ}	3.0	3.6	V	1
	V _{SS} , V _{SSQ}	0	0	V	
Input high voltage	V _{IH}	2.0	V _{CCQ} + 2.0	V	1, 2
Input low voltage	V _{IL}	V _{SSQ} - 2.0	0.8	V	1,3

Notes : 1. All voltage referred to Vss.

2. V_{IH} (max) = 5.6V for pulse width ≤ 3 ns

3. V_{IL} (min) = -2.0V for pulse width ≤ 3 ns

DC Characteristics (Ta = 0 to 70C, Vcc, Vccq = 3.3 V +/- 0.3 V, Vss, Vssq = 0 V)

Parameter	Symbol	- 8	- 7K	- 7J	- 10K	Unit	Test conditions	Notes	
		Max	Max	Max	Max				
Operating current	ICC1	80	80	80	70	mA	Burst length= 1 trc = min	1, 2, 3	
Standby current in power down	ICC2P	2	2	2	2	mA	CKE = VIL, tck = 12 ns	5	
Standby current in power down (input signal stable)	ICC2PS	2	2	2	2	mA	CKE=VIL, tck= infinity	6	
		0.4	0.4	0.4	0.4			6,8	
Standby current in non power down (CAS Latency=2)	ICC2N	15	15	15	15	mA	CKE,CS = VIH, tck = 12ns	4	
		10	10	10	10			4,8	
Standby current in non power down (input signal stable)	ICC2NS	5	5	5	5	mA	CKE = VIH, tck = infinity	4	
Active standby current in power down	ICC3P	6	6	6	6	mA	CKE = VIL, tck = 12 ns, DQ = High-Z	1,2,5	
		5	5	5	5			1,2,5,8	
Active standby current in power down (input signal stable)	ICC3PS	5	5	5	5	mA	CKE = VIL, tck = infinity	2,6	
		4	4	4	4			2,6,8	
Active standby current in non power down	ICC3N	30	30	30	30	mA	CKE,CS = VIH, tck = 12 ns, DQ = High-Z	1,2,4	
		25	25	25	25			1,2,4,8	
Active standby current in non power down (input signal stable)	ICC3NS	20	20	20	20	mA	CKE = VIH, tck = infinity	2,9	
		10	10	10	10			2,8,9	
Burst operating current	(CL= 2)	ICC4	100	120	80	80	mA	tck = min BL = 4	1,2,3
	(CL= 3)	ICC4	155	120	120	120			
Refresh current	ICC5	110	110	110	90	mA	trc = min	3	
Self refresh current	ICC6	1	1	1	1	mA	VIH >=VCC - 0.2 VIL <=0.2V	7	
		0.4	0.4	0.4	0.4			7,8	

Parameter	Symbol	- 8, - 7K, - 7J, -10K		Unit	Test conditions	Notes
		Min	Max			
Input leakage current	I _{LI}	-1	1	μA	0 ≤ V _{in} ≤ V _{CC}	
Output leakage current	I _{LO}	-1.5	1.5	μA	0 ≤ V _{out} ≤ V _{CC} DQ = disable	
Output high voltage	V _{OH}	2.4	-	V	I _{OH} = -2 mA	
Output low voltage	V _{OL}	-	0.4	V	I _{OL} = 2 mA	

Notes : 1. I_{CC} depends on output load condition when the device is selected. I_{CC} (max) is specified at the output open condition.

2. One bank operation.
3. Addresses are changed once per one cycle.
4. Addresses are changed once per two cycles.
5. After Power down mode, CLK operating current.
6. After Power down mode, no CLK operating current.
7. After self refresh mode set, self refresh current.
8. L-Version.
9. Input signals are V_{IH} or V_{IL} fixed.

Capacitance (T_a = 25°C, V_{CC}, V_{CCQ} = 3.3 V + /- 0.3 V)

Parameter	Symbol	Min.	Max.	Unit	Notes
Input capacitance (CLK)	C _{I1}	2.5	4	pF	1, 3, 4
Input capacitance (Signals)	C _{I2}	2.5	5	pF	1, 3, 4
Output capacitance (DQ)	C _O	4.0	6.5	pF	1, 2, 3, 4

- Notes :
1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
 2. DQM = V_{IH} to disable Dout.
 3. This parameter is sampled and not 100% tested.
 4. Measured with 1.4 V bias and 200mV swing at the pin under measurement.

AC Characteristics (Ta = 0 to 70C, Vcc, Vccq = 3.3 V + /- 0.3 V, Vss, Vssq = 0 V)

Parameter		Symbol	- 8		- 7K		- 7J		- 10K		Unit	Notes
			Min	Max	Min	Max	Min	Max	Min	Max		
System clock cycle time	(CL=2)	t _{CK}	12	-	10	-	15	-	15	-	ns	1
	(CL=3)	t _{CK}	8	-	10	-	10	-	10	-		
CLK high pulse width		t _{CKH}	3	-	3	-	3	-	3	-	ns	1
CLK low pulse width		t _{CKL}	3	-	3	-	3	-	3	-	ns	1
Access time from CLK	(CL=2)	t _{AC}	-	8	-	6	-	8	-	9	ns	1, 2
	(CL=3)	t _{AC}	-	6	-	6	-	6	-	8		
Data-out hold time		t _{OH}	3	-	3	-	3	-	3	-	ns	1, 2
CLK to Data-out low impedance		t _{LZ}	2	-	2	-	2	-	2	-	ns	1, 2, 3
CLK to Data-out high impedance (CL = 2,3)		t _{HZ}	-	6	-	6	-	6	-	7	ns	1, 4
Data-in setup time		t _{DS}	2	-	2	-	2	-	2	-	ns	1
Data-in hold time		t _{DH}	1	-	1	-	1	-	1	-	ns	1
Address setup time		t _{AS}	2	-	2	-	2	-	2	-	ns	1
Address hold time		t _{AH}	1	-	1	-	1	-	1	-	ns	1
CKE setup time		t _{CES}	2	-	2	-	2	-	2	-	ns	1, 5
CKE setup time for power down exit		t _{CESP}	2	-	2	-	2	-	2	-	ns	1
CKE hold time		t _{CEH}	1	-	1	-	1	-	1	-	ns	1
Command (\overline{CS} , \overline{RAS} , \overline{CAS} , \overline{WE} , DQM) setup time		t _{CS}	2	-	2	-	2	-	2	-	ns	1
Command (\overline{CS} , \overline{RAS} , \overline{CAS} , \overline{WE} , DQM) hold time		t _{CH}	1	-	1	-	1	-	1	-	ns	1
Ref/Active to Ref/Active command period		t _{RC}	72	-	70	-	70	-	90	-	ns	1
Active to Precharge command period		t _{RAS}	48	120000	50	120000	50	120000	60	120000	ns	1
Active command to column command (same bank)		t _{RCD}	24	-	20	-	20	-	30	-	ns	1
Precharge to active command period		t _{RP}	24	-	20	-	20	-	30	-	ns	1

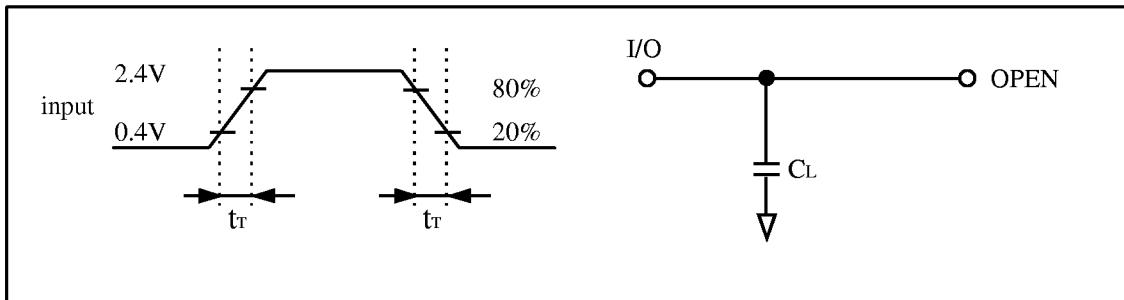
AC Characteristics ($T_a = 0$ to 70°C , $V_{CC}, V_{CCQ} = 3.3\text{ V} + /- 0.3\text{ V}$, $V_{SS}, V_{SSQ} = 0\text{ V}$)
(Continued)

Parameter	Symbol	- 8		- 7K		- 7J		- 10K		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Write recovery or data-in to precharge lead time	t_{RWL}	10	-	10	-	10	-	15	-	ns	1
Active (a) to Active (b) command period	t_{RRD}	16	-	20	-	20	-	20	-	ns	1
Transition time (rise to fall)	t_T	1	5	1	5	1	5	1	5	ns	
Refresh period	t_{REF}	-	64	-	64	-	64	-	64	ms	

- Notes :
1. AC measurement assumes $t_T = 1\text{ns}$. Reference level for timing of input signals is 1.40V .
 2. Access time is measured at 1.40V . Load condition is $C_L = 50\text{pF}$ without termination.
 3. $t_{LZ}(\text{min})$ defines the time at which the outputs achieves the low impedance state.
 4. $t_{HZ}(\text{max})$ defines the time at which the outputs achieves the high impedance state.
 5. t_{CES} define CKE setup time to CKE rising edge except Power down exit command.

Test Condition

- Input and output-timing reference levels: 1.4V
- Input waveform and output load: See following figures



Relationship Between Frequency and Minimum Latency

Parameter		Symbol	- 8		- 7K	- 7J		- 10K		Notes
frequency(MHz)	t _{CK} (ns)		125	83	100	100	66	100	66	
Active command to column command (same bank)		t _{RCD}	3	2	2	2	2	3	2	1
Active command to active command (same bank)		t _{RC}	9	6	7	7	6	9	6	= [t _{RAS} + t _{RP}], 1
Active command to Precharge command (same bank)		t _{RAS}	6	4	5	5	4	6	4	1
Precharge command to active command (same bank)		t _{RP}	3	2	2	2	2	3	2	1
Write recovery or last data-in to Precharge command (same bank)		t _{RWL}	2	1	1	1	1	1	1	1
Active command to active command (different bank)		t _{RRD}	2	2	2	2	2	2	2	1
Self refresh exit time		t _{SREX}	1	1	1	1	1	1	1	
Last data in to active command (Auto Precharge, same bank)		t _{APW}	5	3	3	3	3	4	3	= [t _{RWL} + t _{RP}], 1
Self refresh exit to command input		t _{SEC}	9	6	9	9	6	9	6	= [t _{RC}]
Precharge command to high impedance	(CL=2)	t _{HZP}	-	2	2	-	2	-	2	
	(CL=3)	t _{HZP}	3	3	3	3	3	3	3	
Last data out to active command (auto Precharge) (same bank)		t _{APR}	1	1	1	1	1	1	1	
Last data out to Precharge (early Precharge)	(CL=2)	t _{EP}	-	-1	-1	-	-1	-	-1	
	(CL=3)	t _{EP}	-2	-2	-2	-2	-2	-2	-2	
Column command to column command		t _{CCD}	1	1	1	1	1	1	1	
Write command to data in latency		t _{WCD}	0	0	0	0	0	0	0	
DQM to data in		t _{DD}	0	0	0	0	0	0	0	
DQM to data out		t _{DD}	2	2	2	2	2	2	2	
CKE to CLK disable		t _{CLE}	1	1	1	1	1	1	1	
Register set to active command		t _{RSA}	1	1	1	1	1	1	1	
CS̄ to command disable		t _{CDD}	0	0	0	0	0	0	0	
Power down exit to command input		t _{PEC}	1	1	1	1	1	1	1	

Relationship Between Frequency and Minimum Latency

Parameter		Symbol	- 8		- 7K	- 7J		- 10K		Notes
frequency(MHz)			125	83	100	100	66	100	66	
t _{CK} (ns)			8	12	10	10	15	10	15	
Burst stop to output valid data hold	(CL=2)	I _{BSR}	-	1	1	-	1	-	1	
	(CL=3)	I _{BSR}	2	2	2	2	2	2	2	
Burst stop to output high impedance	(CL=2)	I _{BSH}	-	2	2	-	2	-	2	
	(CL=3)	I _{BSH}	3	3	3	3	3	3	3	
Burst stop to write data ignore		I _{BSW}	0	0	0	0	0	0	0	

Notes : 1. I_{RCD} to I_{RRD} are recommended value.

Package Dimensions

GM72V66841ET/ELT Series (TTP-54D)

